

Title (en)

METHOD TO PRINT MICRONEEDLE PATCHES RAPIDLY

Title (de)

VERFAHREN ZUM SCHNELLEN DRUCKEN VON MIKRONADELPFLASTERN

Title (fr)

PROCÉDÉ POUR IMPRIMER RAPIDEMENT DES PLAQUES DE MICRO-AIGUILLES

Publication

**EP 3416620 A1 20181226 (EN)**

Application

**EP 17752671 A 20170214**

Priority

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- CN 2017073512 W 20170214

Abstract (en)

[origin: WO2017140239A1] A method to achieve rapid 3D printing of microneedle patches. The 3D printing method comprises a printing nozzle of multiple micro-holes and cold plate/platform on which the microneedle-supporting sheet (membrane) is placed. The solution or aqueous solution of microneedle-forming materials is printed onto the cold microneedle-supporting sheet with programed rate of injection from the nozzle and velocity of the nozzle lifting. The relationship between the injection rate and the lifting velocity determines the shape of the microneedle tips. The freshly printed microneedles on the cold sheet are dried in two ways, drying at a temperature close to the ice point of water or drying after a freeze-thaw treatment of the microneedles.

IPC 8 full level

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CPC (source: EP US)

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